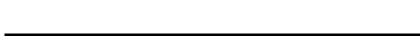
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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR μ PA2352BT1P

DUAL N-CHANNEL MOSFET

DESCRIPTION

The μ PA2352BT1P is a Dual N-channel MOSFET designed for Lithium-Ion battery protection circuit.

Ecologically Flip chip MOSFET for Lithium-Ion battery Protection (EFLIP).

FEATURES

- Monolithic Dual MOSFET
 - Connecting the Drains on the circuit board is not required because the Drains of the FET1 and the FET2 are internally connected.
- 2.5 V drive available and low on-state resistance

Rss(on)1 = 43.0 m Ω MAX. (Vgs = 4.5 V, Is = 2.0 A)

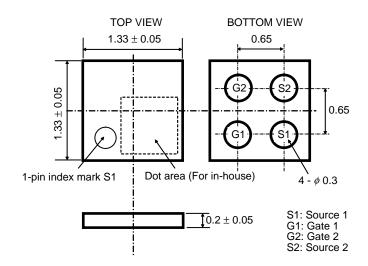
Rss(on)2 = 45.0 m Ω MAX. (Vgs = 4.0 V, Is = 2.0 A)

Rss(on)3 = 55.0 m Ω MAX. (Vgs = 3.1 V, Is = 2.0 A)

Rss(on)4 = 67.0 m Ω MAX. (Vgs = 2.5 V, Is = 2.0 A)

Built-in G-S protection diode against ESD

OUTLINE DRAWING (Unit: mm)



ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA2352BT1P-E4-A Note	4-pin EFLIP-LGA

Note Pb-free (This product does not contain Pb in the external electrode and other parts.)

Remark "-E4" indicates the unit orientation (E4 only).

FET2 FET1 Q Gate 2 Gate 1 Gate Protection Diode Source 2 Source 1 **Body Diode**

EQUIVALENT CIRCUIT

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Source to Source Voltage (Vgs = 0 V) Vsss 24 Gate to Source Voltage (Vss = 0 V) Vgss ±12 Source Current (DC) Note1 Is(DC) ± 4.0 Source Current (pulse) Note2 ±33 IS(pulse) Total Power Dissipation (2 units) Note1 Рτ 0.75 °C **Channel Temperature** 150 Tch Storage Temperature Tstq -55 to +150°C

Notes 1. Mounted on BT resin board of 40.5 mm x 25 mm x 1.5 mmt

2. PW \leq 100 μ s, Duty Cycle \leq 1%

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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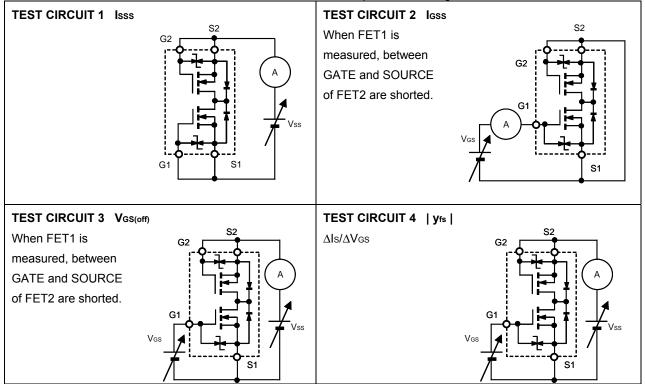


ELECTRICAL CHARACTERISTICS (TA = 25°C) These are common to FET1 and FET2.

		, ,				
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Source Current	Isss	Vss = 24 V, Vgs = 0 V, TEST CIRCUIT 1			10	μΑ
Gate Leakage Current	Igss	V_{GS} = ±12 V, V_{SS} = 0 V, TEST CIRCUIT 2			±10	μA
Gate to Source Cut-off Voltage	V _{GS(off)}	Vss = 10.0 V, Is = 1.0 mA, TEST CIRCUIT 3	0.5	1.0	1.5	V
Forward Transfer Admittance Note	yfs	V _{SS} = 10.0 V, I _S = 2.0 A, TEST CIRCUIT 4	1.8			S
Source to Source On-state	Rss(on)1	V _{GS} = 4.5 V, I _S = 2.0 A, TEST CIRCUIT 5	24.0	35.0	43.0	mΩ
Resistance Note	Rss(on)2	V _{GS} = 4.0 V, I _S = 2.0 A, TEST CIRCUIT 5	25.0	37.0	45.0	mΩ
	Rss(on)3	V _{GS} = 3.1 V, I _S = 2.0 A, TEST CIRCUIT 5	31.5	43.0	55.0	mΩ
	Rss(on)4	V _{GS} = 2.5 V, I _S = 2.0 A, TEST CIRCUIT 5	33.5	55.0	67.0	mΩ
Input Capacitance	Ciss	V _{SS} = 10.0 V, V _{GS} = 0 V, f = 1.0 MHz		720		pF
Output Capacitance	Coss	TEST CIRCUIT 7		130		pF
Reverse Transfer Capacitance	Crss			80		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 20.0 V, I _S = 4.0 A,		2.5		μs
Rise Time	tr	V_{GS} = 4.0 V, R_{G} = 6.0 Ω ,		5.3		μs
Turn-off Delay Time	t _{d(off)}	TEST CIRCUIT 8		5.6		μs
Fall Time	tf			7.1		μs
Total Gate Charge	Q _G	V _{DD} = 16 V, V _{G1S1} = 4.0 V, I _S = 4.0 A,	5.0		nC	
		TEST CIRCUIT 9				
Body Diode Forward Voltage Note	V _{F(S-S)}	I _F = 4.0 A, V _{GS} = 0 V, TEST CIRCUIT 6		1.0		V

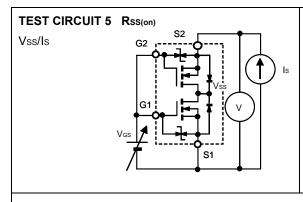
Note Pulsed

Both the FET1 and the FET2 are measured. Test circuits are example of measuring the FET1 side.



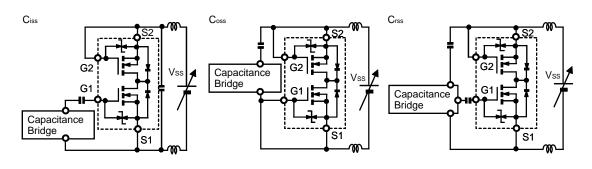
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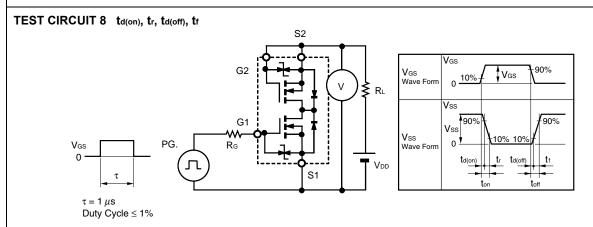


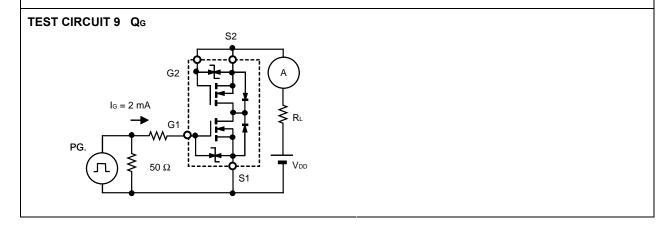


TEST CIRCUIT 6 VF(s-s) When FET1 is measured, FET2 is added VGS +4.5 V. 4.5 V G2 VGS = 0 V S1

TEST CIRCUIT 7

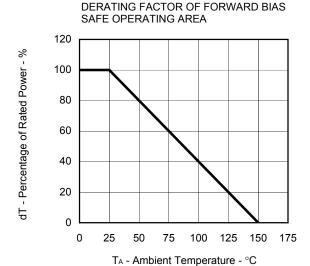




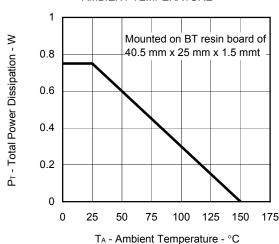


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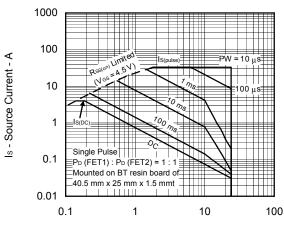
TYPICAL CHARACTERISTICS (TA = 25°C)



TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE

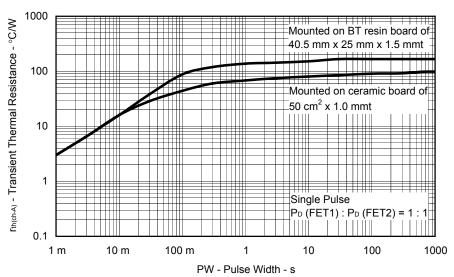


FORWARD BIAS SAFE OPERATING AREA



Vss - Source to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

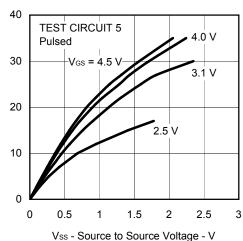


Is - Source Current - A

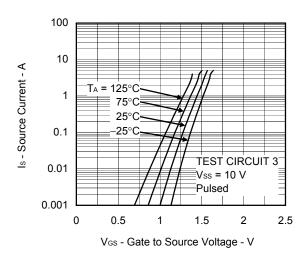
Ves(off) - Gate to Source Cut-off Voltage - V

Rss(on) - Source to Source On-state Resistance - m\Omega

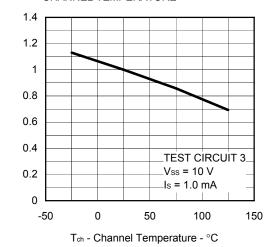
SOURCE CURRENT vs. SOURCE TO SOURCE VOLTAGE



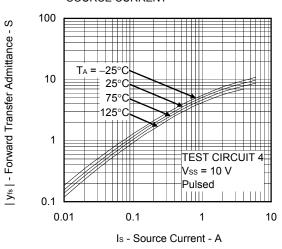
FORWARD TRANSFER CHARACTERISTICS



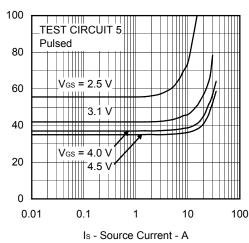
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



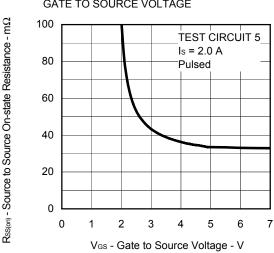
FORWARD TRANSFER ADMITTANCE vs. SOURCE CURRENT



SOURCE TO SOURCE ON-STATE RESISTANCE vs. SOURCE CURRENT

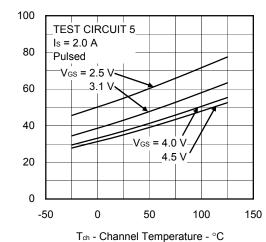


SOURCE TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

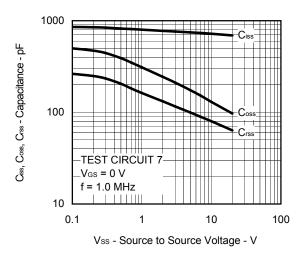


Rss(on) - Source to Source On-state Resistance - mΩ

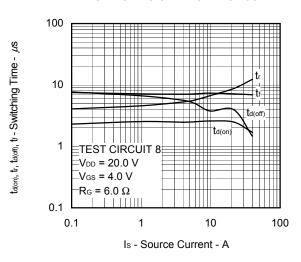
SOURCE TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



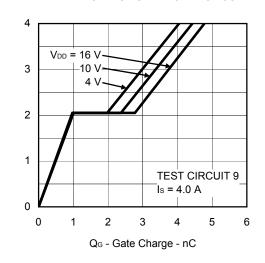
CAPACITANCE vs. SOURCE TO SOURCE VOLTAGE



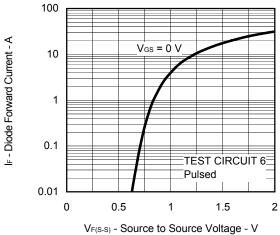
SWITCHING CHARACTERISTICS



DYNAMIC INPUT CHARACTERISTICS



SOURCE TO SOURCE DIODE FORWARD VOLTAGE



Vos - Gate to Source Voltage - V

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